D cket No. 87264.2081 Customer No. 30734

DECLARATION AND POWER OF ATTORNEY

As below named inventor, I hereby declare that:

My residence, post office and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter claimed and for which a patent is sought on the invention entitled A FABRIC COATING COMPOSITION WITH LATENT HEAT EFFECT AND A METHOD FOR FABRICATING THE SAME, the specification of which [X] is attached hereto OR [] was filed on and was amended on (if applicable). Application Serial No.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amende by any amendment referred to above.

I acknowledge the duty to disclose information which is known to me to be material to patentability in accordance with Title 37, Cod of Federal Regulations, Section 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, Section 119 of any foreign application(s) for patent o inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having filing date before that of the application on which priority is claimed:

Prior Foreign Application(s):

Priority Claimed

Number

Country

Day/Month/Year filed

No

91115039

TAIWAN, R.O.C. July 8, 2002

Yes

I hereby claim the benefit under 35 USC Section 119(e) of any United States provisional application(s) listed below.

Prior Provisional Application(s):

Application Number

Filing Date

I hereby claim the benefit under Title 35, United States Code, Section 120 of any United States application(s) listed below and, insofa as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manne provided by the first paragraph of Title 35, United States Code, Section 112, I acknowledge the duty to disclose material information a defined in Title 37, Code of Federal Regulations, Section 1.56(a) which occurred between the filing date of the prior application and th national or PCT international filing date of this application:

Prior U. S. Application(s):

Serial No.

Filing Date

Status: Patented, Pending, Abandoned

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like s made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

The undersigned hereby grant(s) the firm of BAKER & HOSTETLER LLP the power to insert on this Declaration any further identification, including the application number and filing date, which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document

Customer No. 30734

We hereby appoint the following attorney(s) and/or agent(s):

Leo J. Jennings	Reg. No. 32,902
Kenneth J. Sheehan	Reg. No. 36,270
Edna Vassilovski	Reg. No. 42,198
Phong Duy Nguyen	Reg. No. 43,833
Dennis P. Cawley	Reg. No. 44,598
Gregory B. Kang	Reg. No. 45,273
Dawn M. Sims	Reg. No. 47,090
Sean A. Pryor	Reg. No. 48,103
William W. Lewis, III	Reg. No. 48,742
Marc W. Butler	Reg. No. 50,219
Stephen S. Fabry	Reg. No. 51,661

with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith, and all future correspondence should be addressed to the address at the aforementioned customer number. with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith, and all future correspondence should be addressed to:

BAKER & HOSTETLER LLP Washington Square, Suite 1100 1050 Connecticut Avenue, N.W. Washington, D.C. 20036 Tel. 202 861 1500 Fax 202 861 1783

Full name of inventor:	Yen-Hsi LIN				
Inventor's signature:	Yen- Hsi	lin		Date:	92. 6.27
Residence: 2F, NO.88, L	ANE 203, SEC.2, HSI	NG LUNG RD., WEN	I SHAN DIST., TAIWAN, R.O.C		,
Citizenship: TAIWAN,	, R.O.C.				
Mailing Address: NO.6,	CHEN-TIAN ROAD,	TU-CHEN CITY, TA	PEI HSIEN, TAIWAN, R.O.C.		
*******	******	*******	**********	*****	*******
Full name of inventor:	Chun-Hung LIN				
Inventor's signature:	Chun-Hung	Lin		Date	: 92.6.30.

Residence: 3F,NO.24-3, HUA HSI ST., WAN HUA DIST., TAIPEI, TAIWAN, R.O.C.
Citizenship: TAIWAN, R.O.C.
Mailing Address: NO.6, CHEN-TIAN ROAD, TU-CHEN CITY, TAIPEI HSIEN, TAIWAN, R.O.C.

Full name of inventor: Lien-Hua CHIU
Inventor's signature: Lien-Hun Chiu Date: 92.6.27
Residence: 4F, NO.6, ALLEY 7, LANE 17, LIN 19, YUNG YUAN RD., YUNGHO, TAIPEI HSIEN, TAIWAN, R.O.C.
Citizenship: TAIWAN, R.O.C.
Mailing Address: NO.6, CHEN-TIAN ROAD, TU-CHEN CITY, TAIPEI HSIEN, TAIWAN, R.O.C.
Full name of inventor: Shu-Lan YAO
Full name of inventor: Shu-Lan YAO Inventor's signature: Shu-Lan AO Date: 93. 6. 27
<u>,</u>
Inventor's signature: Ghu-Lan AO Date: 93. 6. 27
Inventor's signature: $\frac{1}{2}$ $\frac{1}{2}$ Date: $\frac{1}{2}$ Date
Inventor's signature: $\frac{1}{2}$ $\frac{1}{2}$ Date: $\frac{1}{2}$ Date
Inventor's signature: $\frac{1}{2}$ $\frac{1}{2}$ Date: $\frac{1}{2}$ Date
Inventor's signature: $\frac{1}{2}$ $\frac{1}{2}$ Date: $\frac{1}{2}$ Date
Inventor's signature: $\frac{1}{2}$ $\frac{1}{2}$ Date: $\frac{1}{2}$ Date
Inventor's signature: $\frac{1}{2}$ $\frac{1}{2}$ Date: $\frac{1}{2}$ Date
Inventor's signature: 4hu-lan 140 Date: 92. 6. 27 Residence: 5F, NO.13, LANE 132, KUO CHUNG RD., YUNGHO, TAIPEI HSIEN, TAIWAN, R.O.C. Citizenship: TAIWAN, R.O.C. Mailing Address: NO.6, CHEN-TIAN ROAD, TU-CHEN CITY, TAIPEI HSIEN, TAIWAN, R.O.C.
Inventor's signature: 6/10-lan //O Residence: 5F, NO.13, LANE 132, KUO CHUNG RD., YUNGHO, TAIPEI HSIEN, TAIWAN, R.O.C. Citizenship: TAIWAN, R.O.C. Mailing Address: NO.6, CHEN-TIAN ROAD, TU-CHEN CITY, TAIPEI HSIEN, TAIWAN, R.O.C. Full name of inventor: Cheng-Chu LIN
Inventor's signature: Ghu-lan AO Residence: 5F, NO.13, LANE 132, KUO CHUNG RD., YUNGHO, TAIPEI HSIEN, TAIWAN, R.O.C. Citizenship: TAIWAN, R.O.C. Mailing Address: NO.6, CHEN-TIAN ROAD, TU-CHEN CITY, TAIPEI HSIEN, TAIWAN, R.O.C. Full name of inventor: Cheng-Chu LIN Inventor's signature: Cheng-Chu LIN Date: 92. 6. 27 Date: 92. 6. 27